



HONG KONG ELECTRONICS SYMPOSIUM 2026

**“THE NEXT GENERATION OF AI:
POWERING MOBILITY AND INNOVATION”**

VENUE

Grand Ballroom, Royal Plaza Hotel, Mongkok

DATE

11 May, 2026 (Mon)

TIME

9:00AM – 5:00PM

FEE

MEMBER

NON -

MEMBER

EARLY BIRD

on or before
24 April, 2026

HK\$800

HK\$1000

STANDARD

HK\$1300

HK\$1500

Join us at the Hong Kong Electronics Symposium 2026 to explore “The Next Generation of AI: Powering Mobility and Innovation.” We will gather leading experts from Chinese Mainland and overseas to share insights on how AI is transforming transportation, smart infrastructure, and industrial systems—an excellent opportunity to connect, learn, and be part of the future of intelligent innovation. This year’s program will highlight emerging applications that are reshaping global mobility trends. Attendees can also engage with innovators driving forward next-generation sustainable and smart technologies.

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THE HONG KONG INSTITUTION OF ENGINEERS
香港工程師學會

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電子分部

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Hong Kong Electronics Symposium 2026

The Next Generation of AI: Powering Mobility and Innovation

11 May 2026, Grand Ballroom, Royal Plaza Hotel, Mongkok

PRELIMINARY PROGRAMME

Time	Activity	Speaker
08:30 – 09:00	Registration	
09:00	Welcome Speech	Ir Dr. YH SHUM Chairman, HKIE Electronics Division
	Opening Speech	Ir Alice CHOW President, HKIE
Award Presentation for Hong Kong Electronics Competition 2026 (HKEPC2026)		
	Keynote Speech Accelerating AI and Digital Economy Development in Hong Kong	Mr. Yee Wai Daniel CHEUNG, JP Acting Commissioner for Digital Policy Digital Policy Office Hong Kong SAR Government
Group Photo		
	Address from GuangDong Institute of Electronics	Prof. Cairong ZOU Chairman GuangDong Institute of Electronics
Tea Break		
	Talk 1 Empowering by AI+: Challenges in the New Tech Era	Ir Prof. Hon William Kam-fai WONG Vice Chairman & Secretary General, HK Alliance of Technology and Innovation Advisor, Our Hong Kong Foundation Legislative Councillor
	Talk 2 Co-GenAI: A Novel Fusion-Driven Framework	Prof. Hongxia YANG Associate Dean of the Faculty of Computing and Mathematical Sciences and Executive Director of the PolyU Academy Hong Kong Polytechnic University
	Talk 3 A Global-Oriented Standards Framework work for the Low-Altitudes Economy	Prof. Chitin HON Department of Engineering and Science, Faculty of Innovation Engineering Macau University of Science and Technology
	Panel Discussion (Morning) Standardization and Current Development of AI	<p><u>Facilitator</u> Ir Prof. KF TSANG Council Member, HKIE Past Chairman, HKIE Electronics Division</p> <p><u>Panelists</u> Hon Duncan CHIU, MH Legislative Councillor</p> <p>Prof. Chitin HON Department of Engineering and Science, Faculty of Innovation Engineering Macau University of Science and Technology</p> <p>Ir Prof. Hon William Kam-fai WONG Vice Chairman & Secretary General, HK Alliance of Technology and Innovation Advisor, Our Hong Kong Foundation Legislative Councillor</p> <p>Prof. Hongxia YANG Associate Dean of the Faculty of Computing and Mathematical Sciences and Executive Director of the PolyU Academy Hong Kong Polytechnic University</p>
Group photo & souvenir presentation		

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The Next Generation of AI: Powering Mobility and Innovation
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Time	Activity	Speaker
12:40-14:00	Lunch	
14:00	Keynote Speech	Ir Vincent CHOW, JP Acting Director Electrical and Mechanical Services Department Hong Kong SAR Government
	Talk 4 From Data to Movement: AI for the Next Generation of Smart Micro-Mobility	Mr. Steve NG General Manager and Chief Research Officer LocoBike
	Talk 5 AI-Powered Mobile Traffic Control and Surveillance System for Enhancing Road Safety in Hong Kong	Mr. Eric LEUNG IT Project Manager Autotoll Limited
	Tea Break	
	Talk 6 Hikvision Guanlan AI Large Model: Breaking the Isolation of Vision and Language, Facilitating Digital Transformation in Thousands of Industries	Mr. House ZHU Business Development Manager Hikvision Technology Pte. Ltd.
	Talk 7 Huawei's Service Experience of AI Applications	To be advised Huawei
	Talk 8 Using Physics-based Models and AI for Virtual Manufacturing of Batteries	Dr. Masoud JABBARI Assistant Professor and Deputy Director of Postgraduate Research Assistant Professor, School of Mechanical Engineering, University of Leeds (UK) Visiting Researcher, School of Physics and Engineering, University of York (UK)
	Panel Discussion (Afternoon) Next Generation of AI for Smart Mobility and Sustainable Cities	Facilitator Mr. Simon WONG CEO, Logistics and Supply Chain MultiTech R&D Centre Panelists Mr. Karel AU Chief Executive Officer Autotoll Limited Mr. Ken CHING Chairman LocoBike Dr. Masoud JABBARI Assistant Professor and Deputy Director of Postgraduate Research Assistant Professor, School of Mechanical Engineering, University of Leeds (UK) Visiting Researcher, School of Physics and Engineering, University of York (UK) Ir Timothy WONG Senior Engineer Electrical and Mechanical Services Department Hong Kong SAR Government To be advised Huawei
	Group photo & souvenir presentation	
	Closing Speech	Ir Andy LAM OC Chairman, HKES 2026 Deputy Chairman, HKIE Electronics Division
17:00	End	

**Programme is subject to change.

Prepared: Veronica Cheng

Date: 16 March 2026